



2.0x1.25mm SMD CHIP LED LAMP

PRELIMINARY SPEC

Features

- 2.0X1.25mm SMT LED,0.5mm MAX.THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- Rohs Compliant.

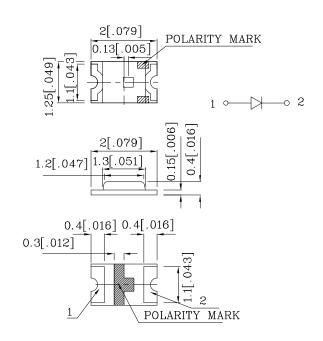




Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (TA=25°C)		VG (InGaAlP)	Unit	
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	IF	30	mA	
Forward Current (peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	Рт	75	mW	
Operating Temperature	TA	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		

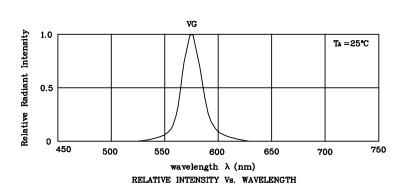


Operating Characteristi (TA=25°C)	VG (InGaAlP)	Unit	
Forward Voltage (Typ.) (IF=20mA)	VF	2.1	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength of Peak Emission (Typ.) (IF=20mA)	λΡ	574	nm
Wavelength of Dominant Emission (Typ.) (IF=20mA)	λ D	570	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	20	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	15	pF

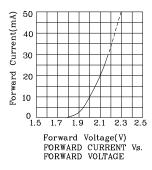
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
ZVG54W-4	Green	InGaAlP	Water Clear	10	39	574	110°
Published Date	: FEB 25,2008	Drawin	ng No :SDSA4451	V3	Check	xed : B.L.LIU	P.1/4

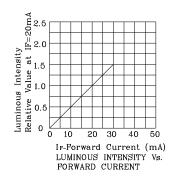


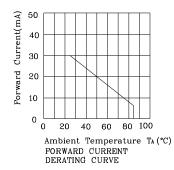
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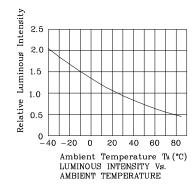


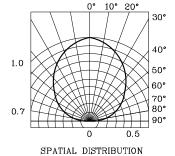
❖ VG







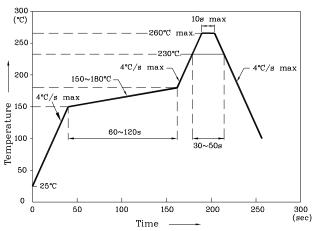






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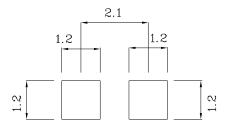
Reflow Soldering Profile For Lead-free SMT Process.

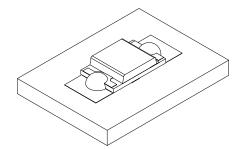


- Notes:
- $1.\,\mbox{Maximum}$ soldering temperature should not exceed 260°C.
- 2.Recommended reflow temperature: 145°c-260°C.
- 3.Do not put stress to the epoxy resin during high temperatures conditions.

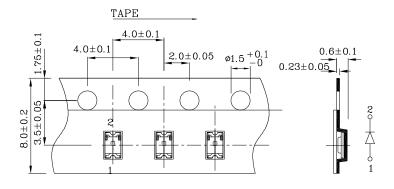
♦ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

❖ The device has a single mounting surface. The device must be mounted according to the specifications.





❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

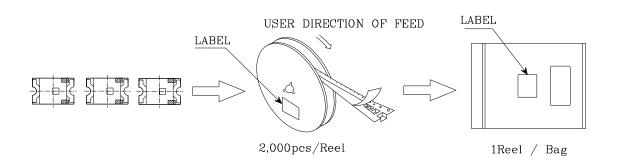
Note: Accuracy may depend on the sorting parameters.

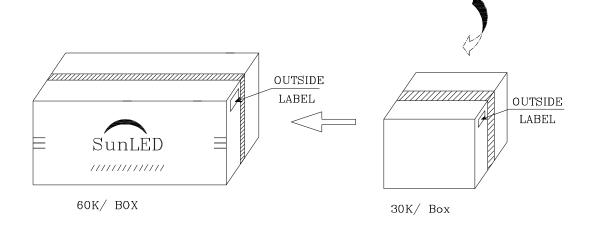


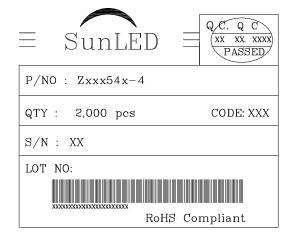
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PACKING & LABEL SPECIFICATIONS

ZVG54W-4







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